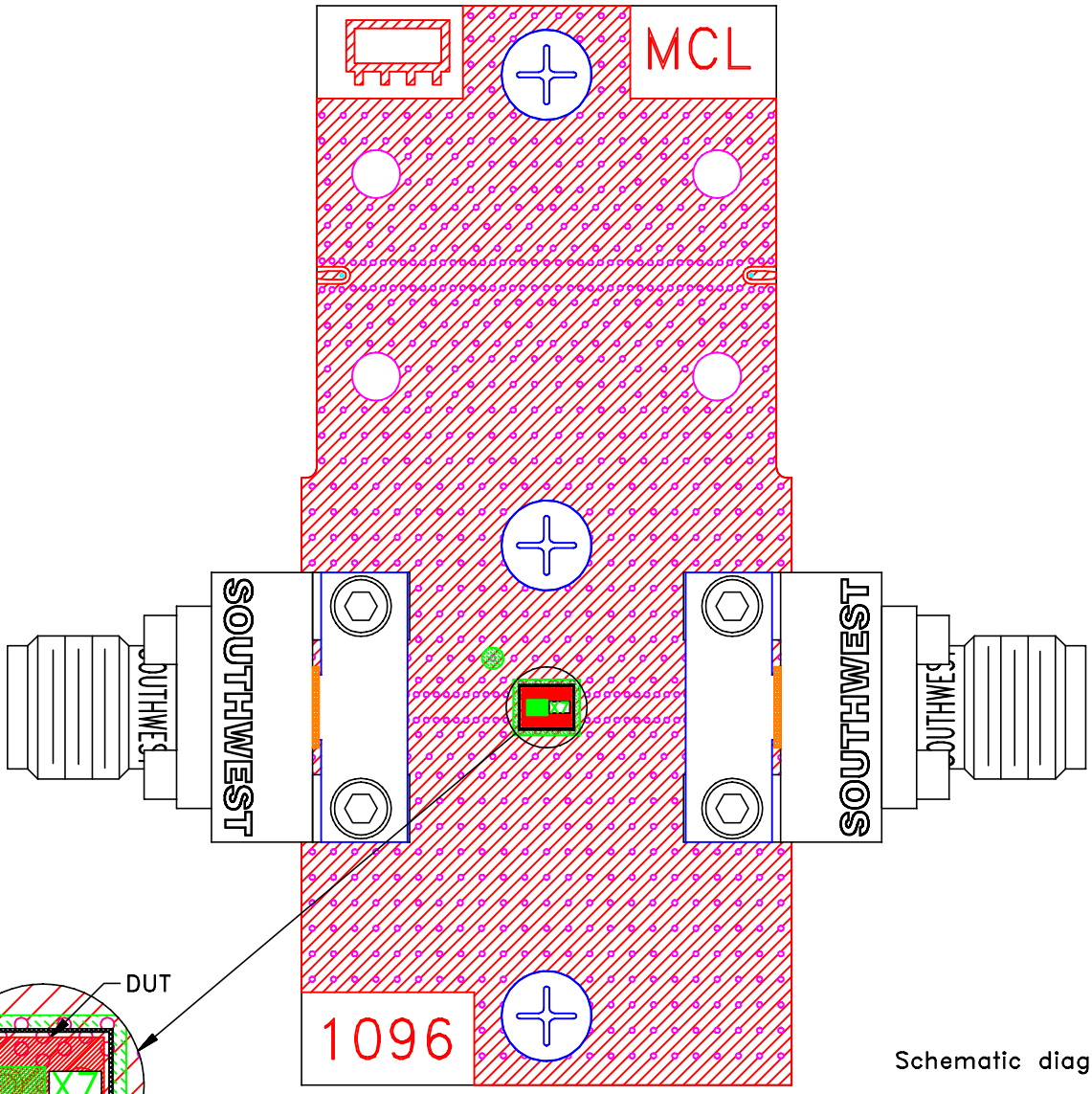
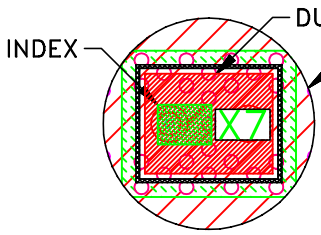
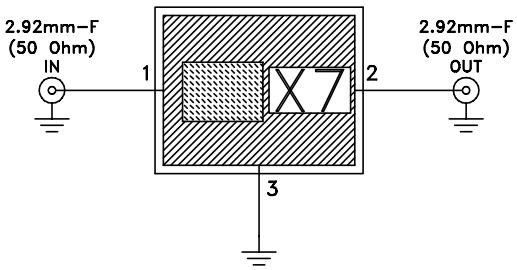
Evaluation Board and Circuit

TB-LFHK-700+

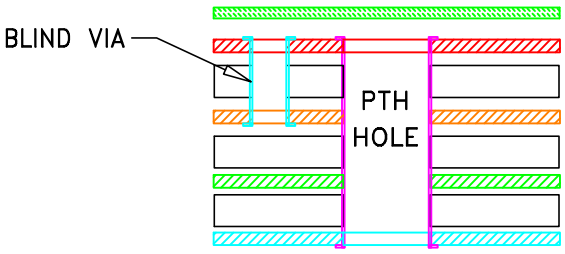




Schematic diagram



STACK-UP DIAGRAM



-TOP-SOLDERMASK.
-COPPER LAYER 1, .5 OZ. + PLATING
-CORE, .0051 MEGTRON 6 R-5775(G), CLOTH STYLE:1080
-COPPER LAYER 2, .5 OZ. + PLATING.
-PREPREG, .0041 MEGTRON 6 R-5670(G)
-COPPER LAYER 3, .5 OZ.
-CORE, .0051 MEGTRON 6 R-5775(G), CLOTH STYLE:1080
-COPPER LAYER 4, .5 OZ. + PLATING

Notes:

1. PCB Material: MEGTRON-6 R5775(G) OR Equivalent, Dielectric Constant=3.6
2. Total finished thickness: .023 inch
3. 50 Ohm 2.92mm Female End Launch Connector.

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